

Low $V_{CE(sat)}$ Transistor(Strobe flash)

2SD2098 / 2SD2118 / 2SD2097 / 2SD2166

●Features

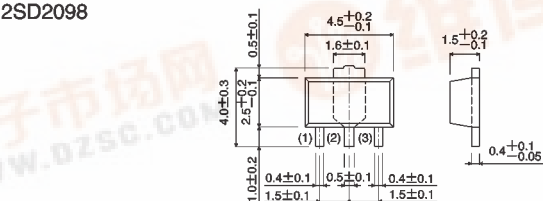
- 1) Low $V_{CE(sat)}$.
 $V_{CE(sat)} = 0.25V$ (Typ.)
($I_C / I_B = 4A / 0.1A$)
- 2) Excellent DC current gain characteristics.
- 3) Complements the
2SB1386 / 2SB1412 / 2SB1326 /
2SB1436.

●Structure

Epitaxial planar type
NPN silicon transistor

●External dimensions (Units: mm)

2SD2098

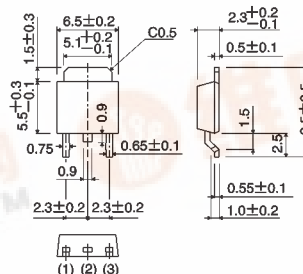


ROHM : MPT3
EIAJ : SC-62

Abbreviated symbol: AH*

- (1) Base
- (2) Collector
- (3) Emitter

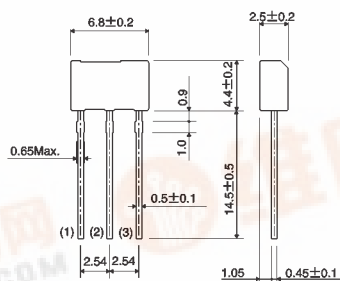
2SD2118



ROHM : CPT3
EIAJ : SC-63

- (1) Base
- (2) Collector
- (3) Emitter

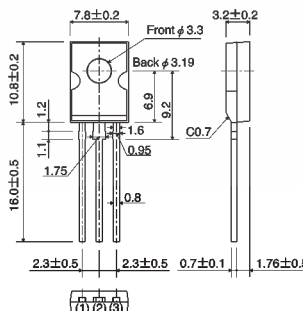
2SD2097



ROHM : ATV

- (1) Emitter
- (2) Collector
- (3) Base

2SD2166



ROHM : TO-126FP

- (1) Emitter
- (2) Collector
- (3) Base



Transistors

2SD2098 / 2SD2118 / 2SD2097 / 2SD2166

●Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Collector-base voltage		V _{CBO}	50	V
Collector-emitter voltage		V _{CEO}	20	V
Emitter-base voltage		V _{EBO}	6	V
Collector current		I _C	5	A (DC)
		I _{CP}	10	A (Pulse) *1
Collector power dissipation	2SD2098	P _C	0.5	W *2
			2	
	2SD2118		1	
			10	
	2SD2097		1	W *3
	2SD2116		1.5	
			5	W (T _C =25℃)
Junction temperature		T _J	150	℃
Storage temperature		T _{stg}	−55~+150	℃

*1 Single pulse $P_w=10ms$

*2 When mounted on a 40×40×0.7 mm ceramic board.

*3 Printed circuit board glass epoxy board, 1.6 mm thick with copper plating 100mm² or larger.

●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	50	—	—	V	$I_C=50\mu A$
Collector-emitter breakdown voltage	BV_{CEO}	20	—	—	V	$I_C=1mA$
Emitter-base breakdown voltage	BV_{EBO}	6	—	—	V	$I_E=50\mu A$
Collector cutoff current	I_{CBO}	—	—	0.5	μA	$V_{CB}=40V$
Emitter cutoff current	I_{EBO}	—	—	0.5	μA	$V_{EB}=5V$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	0.25	1.0	V	$I_C/I_B=4A/0.1A$ *
DC current transfer ratio	h_{FE}	120	—	390	—	$V_{CE}=2V$, $I_C=0.5A$ *
Transition frequency	f_T	—	150	—	MHz	$V_{CE}=6V$, $I_E=-50mA$, $f=100MHz$
Output capacitance	C_{ob}	—	30	—	pF	$V_{CE}=20V$, $I_E=0A$, $f=1MHz$

* Measured using pulse current.

●Packaging specifications and h_{FE}

Type	h_{FE}	Package	Taping			Bulk
		Code	T100	TL	TV2	—
		Basic ordering unit (pieces)	1000	2500	2500	1000
2SD2098	QR		○	—	—	—
2SD2118	QR		—	○	—	—
2SD2097	QR		—	—	○	—
2SD2166	QR		—	—	—	○

h_{FE} values are classified as follows :

Item	Q	R
h_{FE}	120~270	180~390

●Electrical characteristic curves

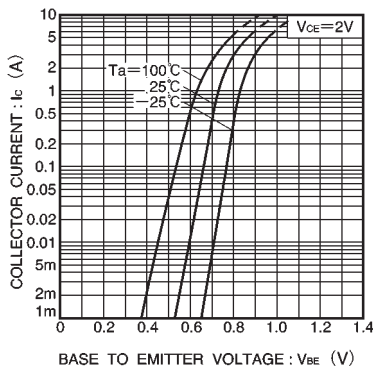


Fig.1 Grounded emitter propagation characteristics

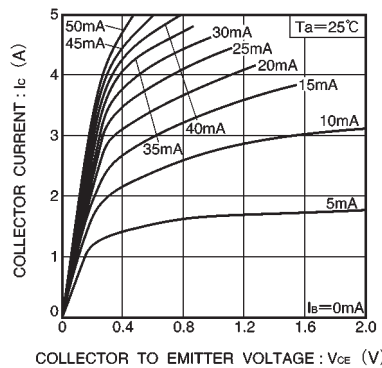


Fig.2 Grounded emitter output characteristics

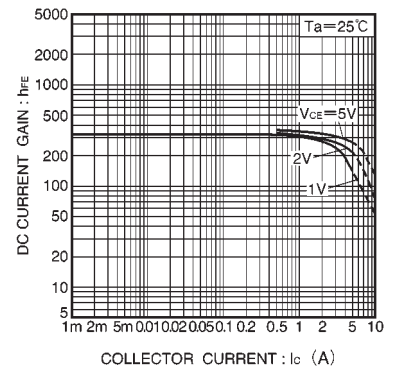


Fig.3 DC current gain vs. collector current (I)

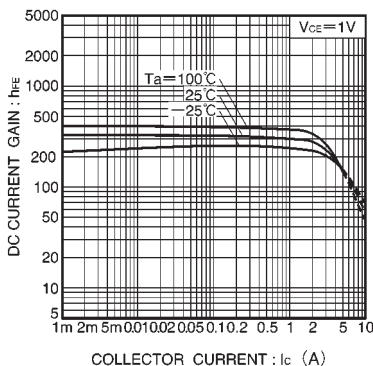


Fig.4 DC current gain vs. collector current (II)

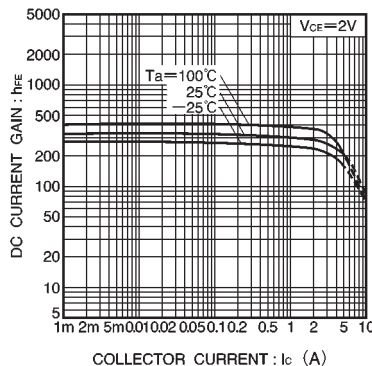


Fig.5 DC current gain vs. collector current (III)

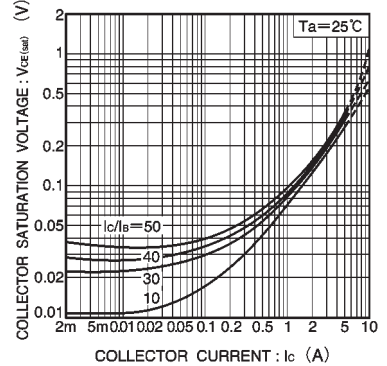


Fig.6 Collector-emitter saturation voltage vs. collector current (I)

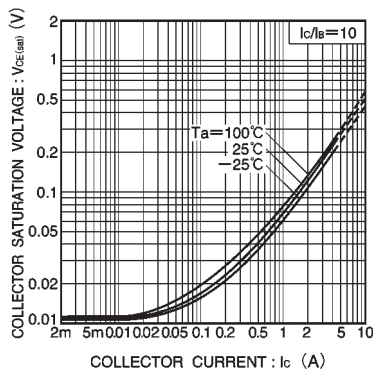


Fig.7 Collector-emitter saturation voltage vs. collector current (II)

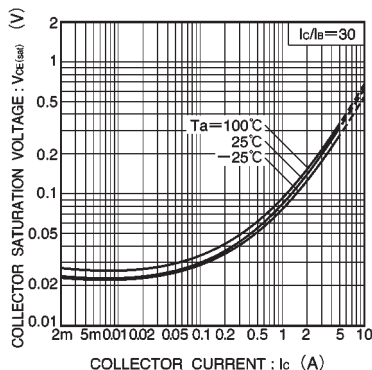


Fig.8 Collector-emitter saturation voltage vs. collector current (III)

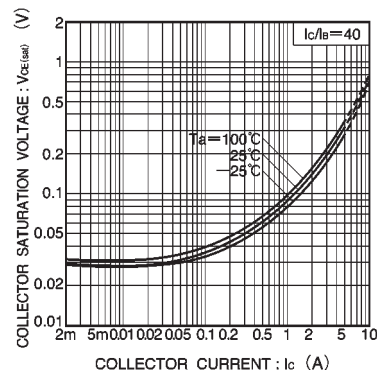


Fig.9 Collector-emitter saturation voltage vs. collector current (IV)

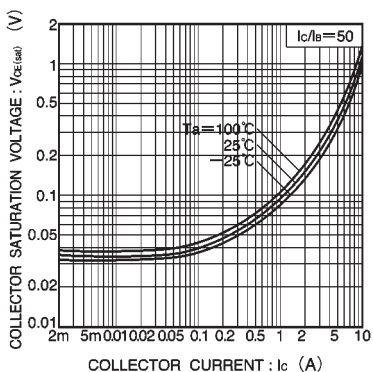


Fig.10 Collector-emitter saturation voltage vs. collector current (V)

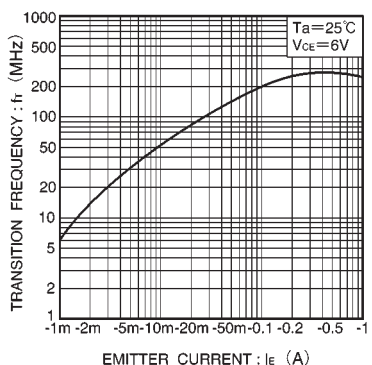


Fig.11 Gain bandwidth product vs. emitter current

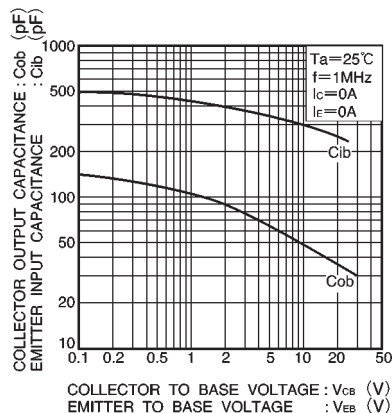


Fig.12 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage

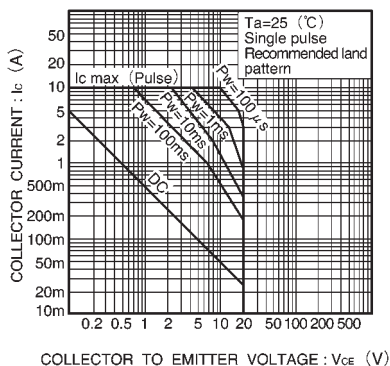


Fig.13 Safe operating area (2SD2098)

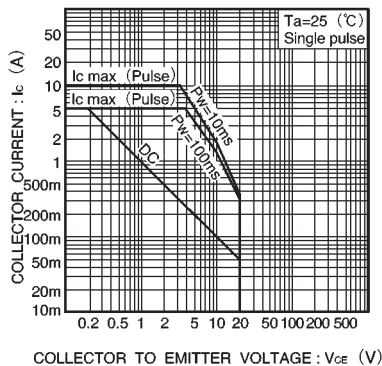


Fig.14 Safe operating area (2SD2118)